

# Asynchronous Communication Interface Adapter (ACIA)



**GOULD**  
Electronics

## S6850/S68A50/S68B50

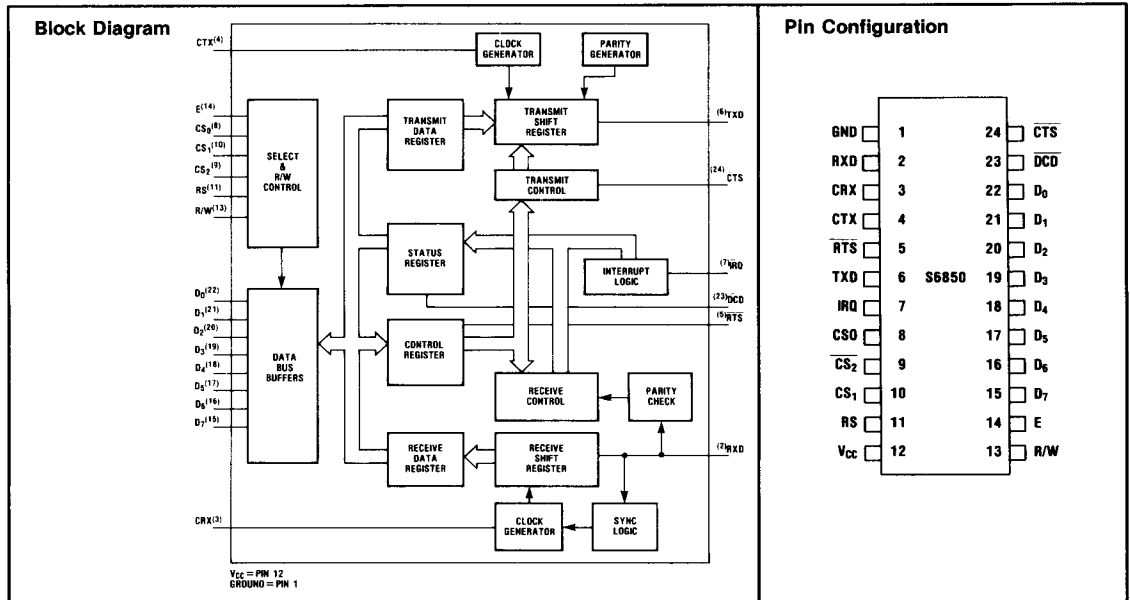
### Features

- 8-Bit Bi-directional Data Bus for Communication with MPU
- False Start Bit Deletion
- Peripheral/Modem Control Functions
- Double Buffered Receiver and Transmitter
- One or Two Stop Bit Operation
- Eight and Nine-Bit Transmission With Optional Even and Odd Parity
- Parity, Overrun and Framing Error Checking
- Programmable Control Register
- Optional +1, +16, and +64 Clock Modes
- Up to 500,000 bps Transmission

### Functional Description

The S6850 Asynchronous Communications Interface Adapter (ACIA) provides the data formatting and control to interface serial asynchronous data communications to bus organized systems such as the S6800 Microprocessing Unit.

The S6850 includes select enable, read/write, interrupt and bus interface logic to allow data transfer over an 8-bit bi-directional data bus. The parallel data of the bus system is serially transmitted and received by the asynchronous data interface, with proper formatting and error checking. The functional configuration of the ACIA is programmed via the data bus during system initialization. Word lengths, clock division ratios and transmit control through the Request to Send output may be programmed. For modem operation three control lines are provided. These lines allow the ACIA to interface directly with the S6860 0-600 bps digital modem.



# S6850/S68A50/S68B50

## Absolute Maximum Ratings\*

Supply Voltage .....	- 0.3V to + 7.0V
Operating Temperature Range .....	0°C to + 70°C
Input Voltage .....	- 0.3V to + 7.0V
Storage Temperature Range .....	- 55°C to + 150°C

\*NOTE: This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields; however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit.

## DC (Static) Characteristics: ( $V_{CC} = 5.0V \pm 5\%$ , $T_A = 25^\circ C$ , unless otherwise noted.)

Symbol	Characteristic	Min.	Typ.	Max.	Unit	
$V_{IHT}$	Input High Threshold Voltage	+ 2.0	—	—	Vdc	
$V_{ILT}$	Input Low Threshold Voltage	—	—	+ 0.8	Vdc	
$I_{IN}$	Input Leakage Current ( $V_{IN} = 0$ to 5.0 Vdc) R/W, RS, CS <sub>0</sub> , CS <sub>1</sub> , $\overline{CS}_2$ , Enable	—	1.0	2.5	$\mu$ A <sub>dc</sub>	
$I_{TSI}$	Three-State (Off State) Input Current ( $V_{IN} = 0.4$ to 2.4 Vdc, $V_{CC} = \text{max}$ ) D <sub>0</sub> , D <sub>7</sub>	—	2.0	10	$\mu$ A <sub>dc</sub>	
$V_{OH}$	Output High Voltage ( $I_{LOAD} = 100\mu$ A <sub>dc</sub> , Enable Pulse Width 25 $\mu$ s) All Outputs Except $\overline{IRQ}$	+ 2.4	—	—	Vdc	
$V_{OL}$	Output Low Voltage ( $I_{LOAD} = 1.6$ mA <sub>dc</sub> ) Enable Pulse Width 25 $\mu$ s	—	—	+ 0.4	Vdc	
$I_{LOH}$	Output Leakage Current (Off State) $\overline{IRQ}$	—	1.0	10	$\mu$ A <sub>dc</sub>	
$P_D$	Power Dissipation	—	300	525	mW	
$C_{IN}$	Input Capacitance ( $V_{IN} = 0$ , $T_A = 25^\circ C$ , $f = 1.0$ MHz) D <sub>0</sub> - D <sub>7</sub> R/W, RS, CS <sub>0</sub> , CS <sub>1</sub> , $\overline{CS}_2$ , RXD, $\overline{CTD}$ , $\overline{DCD}$ , CTX, CRX Enable	—	—	10 7.0 7.0	12.5 7.5 7.5	pF
$C_{OUT}$	Output Capacitance ( $V_{IN} = 0$ , $T_A = 25^\circ C$ , $f = 1.0$ MHz)	—	—	10	pF	

Figure 1. Enable Signal Characteristics

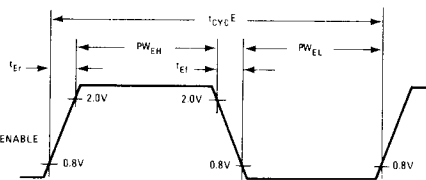
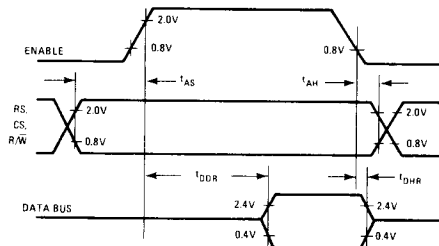


Figure 2. Bus Read Timing Characteristics



## S6850/S68A50/S68B50

### AC (Dynamic) Characteristics

Loading = 130pF and one TTL load for D<sub>0</sub>-D<sub>7</sub> = 20pF and 1 TTL load for RTS and TXD = 100pF and 3KΩ to V<sub>CC</sub> for IRQ.

Symbol	Parameter	S6850		S68A50		S68B50		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
t <sub>CYC(E)</sub>	Enable Cycle Time	1000		666		500		ns
PW <sub>EH</sub>	Enable Pulse Width, High	450		280		220		ns
PW <sub>EL</sub>	Enable Pulse Width, Low	430		280		210		ns
t <sub>ER</sub> , t <sub>EF</sub>	Enable Pulse Rise and Fall Times		25		25		25	ns
t <sub>AS</sub>	Setup Time, Address and R/W Valid to Enable Positive Transition	160		140		70		ns
t <sub>AH</sub>	Address Hold Time	10		10		10		ns
t <sub>DDR</sub>	Data Delay Time, Read		320		220		180	ns
t <sub>DHR</sub>	Data Hold Time, Read	10		10		10		ns
t <sub>DSW</sub>	Data Setup Time, Write	195		80		60		ns
t <sub>DHW</sub>	Data Hold Time, Write	10		10		10		ns

### Transmit/Receive Characteristics

Symbol	Characteristic	Min.	Typ.	Max.	Unit
f <sub>C</sub>	<ul style="list-style-type: none"> <li>+ 1 mode</li> <li>+ 16 mode</li> <li>+ 64 mode</li> </ul>			<ul style="list-style-type: none"> <li>500</li> <li>800</li> <li>800</li> </ul>	<ul style="list-style-type: none"> <li>KHz</li> <li>KHz</li> <li>KHz</li> </ul>
PW <sub>CL</sub>	Clock Pulse Width, Low State	600			nsec
PW <sub>CH</sub>	Clock Pulse Width, High State	600			nsec
t <sub>TDD</sub>	Delay Time, Transmit Clock to Data Out			1.0	μsec
t <sub>RDSU</sub>	Set Up Time, Receive Data	500			nsec
t <sub>RDH</sub>	Hold Time, Receive Data	500			nsec
t <sub>IRQ</sub>	Delay Time, Enable to IRQ Reset			1.2	μsec
t <sub>RTS</sub>	Delay Time, Enable to RTS			1.0	μsec

Figure 3. Bus Write Timing Characteristics

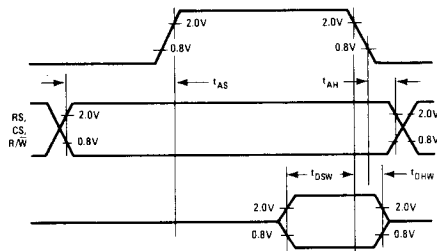


Figure 4. Bus Timing Test Loads

